

ANNOUNCEMENT

For immediate release

E Fund (HK) Yield Enhanced Bond Fund I (the “Issuer”)

ANNOUNCEMENT OF ADDENDUM TO THE PRIVATE PLACING MEMORANDUM

The Issuer wishes to make the following announcements.

The Issuer has issued a third addendum dated 9 May 2025 to its Private Placing Memorandum dated March 2022 (“**PPM**”), as amended and supplemented by a first addendum to the PPM dated 10 May 2022 and a second addendum to the PPM dated 3 August 2022.

For further information in relation to the above announcement, please contact Campbells LLP.

Email: RSearle@campbellslegal.com; palphart@campbellslegal.com

Tel: +1 345 949 2648

Dated: 9 May 2025

END OF ANNOUNCEMENT